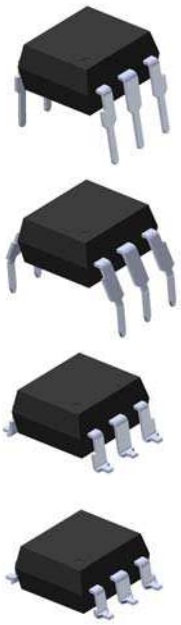
6 PIN DIP PHOTOTRANSISTOR AC INPUT PHOTOCOUPLER

H11AAX Series

Features

- H11AAX series: H11AA1, H11AA2, H11AA3, H11AA4
- High isolation voltage between input and output
  Viso = 5000 Vrms
- Creepage distance >7.62 mm
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved



Description

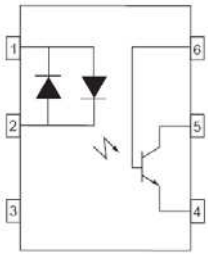
The H11AAX series of devices each consist of two infrared emitting diode, connected in inverse parallel, optically coupled to a phototransistor detector.

They are packaged in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- AC line monitor
- Unknown polarity DC sensor
- Telephone line interface

Schematic



1. Anode / Cathode
2. Cathode / Anode
3. No Connection
4. Emitter
5. Collector
6. Base

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Absolute Maximum Ratings (T_a=25℃)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	60	mA
	Peak forward current (t = 10μs)	I_{FM}	1	A
	Power dissipation (T_A = 25℃)	P_D	120	mW
	Derating factor (above 90℃)		3.8	mW/℃
Output	Power dissipation (T_A = 25℃) No derating up to 100℃	P_C	150	mW
	Collector-Emitter voltage	V_{CEO}	80	V
	Collector-Base voltage	V_{CBO}	80	V
	Emitter-Collector voltage	V_{ECO}	7	V
Total power dissipation		P_{tot}	200	mW
Isolation voltage *1		V_{iso}	5000	Vrms
Operating temperature		T_{opr}	-55~+100	℃
Storage temperature		T_{stg}	-55~+125	℃
Soldering temperature *2		T_{sol}	260	℃

Notes

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

*2 For 10 seconds.

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Electrical Characteristics (T_a=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward voltage	V_F	-	1.2	1.5	V	I_F = ±10mA
Input capacitance	C_{in}	-	80	-	pF	V = 0, f = 1MHz

Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Collector-Emitter dark current	I_{CEO}	-	-	50	nA	V_{CE} = 10V, I_F = 0mA
Collector-Emitter breakdown voltage	BV_{CEO}	80	-	-	V	I_C = 1mA
Collector-Base breakdown voltage	BV_{CBO}	80	-	-	V	I_C = 0.1mA
Emitter-Collector breakdown voltage	BV_{ECO}	7	-	-	V	I_E = 0.1mA
Collector-Emitter capacitance	C_{CE}	-	10	-	pF	VCE = 0V, f = 1MHz

Transfer Characteristics

Parameter		Symbol	Min.	Typ.*	Max.	Unit	Condition
Current Transfer Ratio	H11AA1	CTR	20	-	-	%	I_F = ±10mA ,V_{CE} = 10V
	H11AA2		10	-	-		
	H11AA3		50	-	-		
	H11AA4		100	-	-		
CTR Symmetry			0.5	-	2.0		I_F = ±10mA ,V_{CE} = 10V
Collector-emitter saturation voltage		$V_{CE(sat)}$	-	-	0.4	V	I_F = ±10mA , I_C = 0.5mA
Isolation resistance		R_{IO}	10^{11}	-	-	Ω	V_{IO} = 500Vdc
Input-output capacitance		C_{IO}	-	0.7	-	pF	V_{IO} = 0, f = 1MHz
Turn-on time		T_{on}	-	-	10	μs	V_{CC} = 10V, I_C = 10mA, R_L = 100Ω
Turn-off time		T_{off}	-	-	10		
Rise time		T_r	-	-	10		
Fall time		T_f	-	-	10		

* Typical values at T_a = 25℃

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Typical Performance Curves

Figure 1. Forward Current vs Forward Voltage

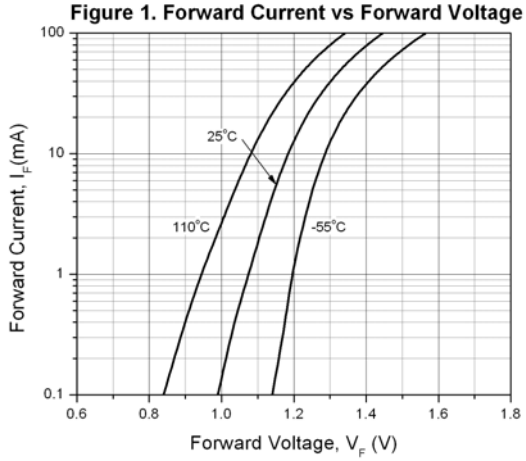

Figure 2. Current Tranfer Ratio vs Forward Current

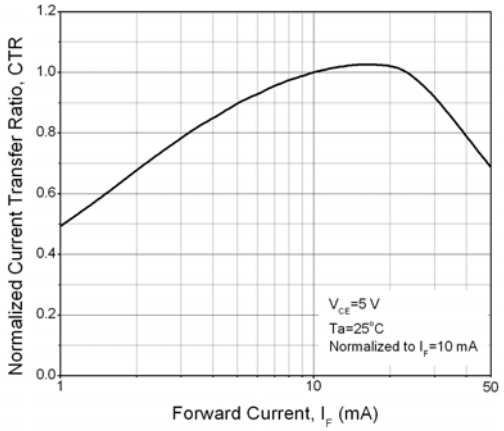

Figure 3. Current Tranfer Ratio vs Ambient Temperature

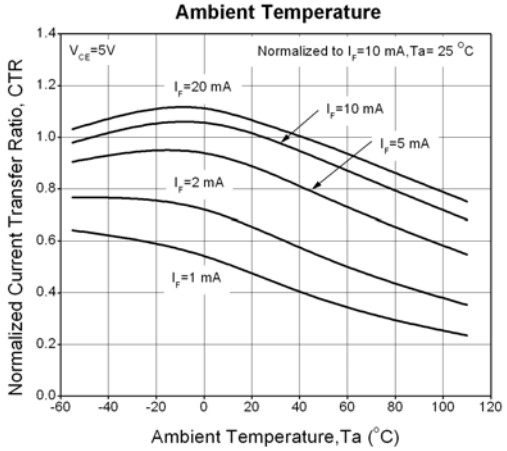

Figure 4. Current Transfer Ratio (Saturated) vs Base-Emitter Resistance

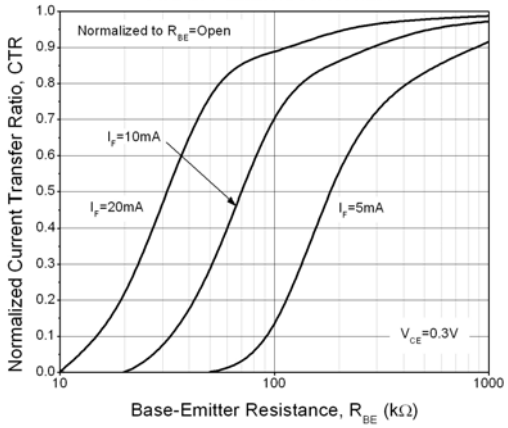

Figure 5. Current Transfer Ratio (Unsaturated) vs Base-Emitter Resistance

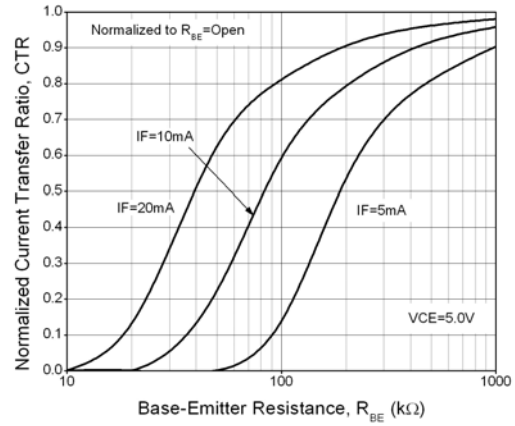

Figure 6. Dark Current vs Ambient Temperature

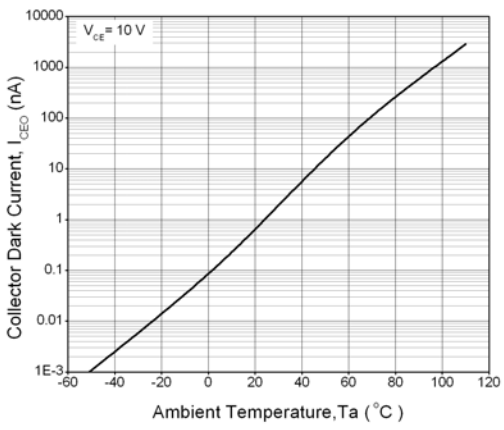

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Figure 7. Collector-Emitter Saturation Voltage vs Collector Current

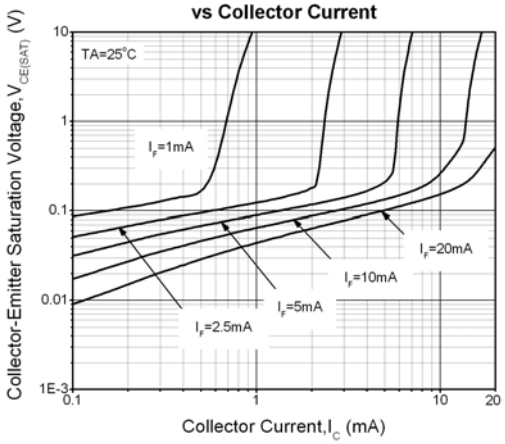


Figure 8. Switching Time vs Load Resistance

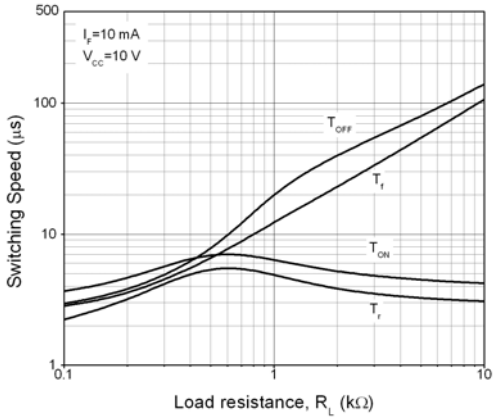


Figure 9. Turn-on Time vs Base-Emitter Resistance)

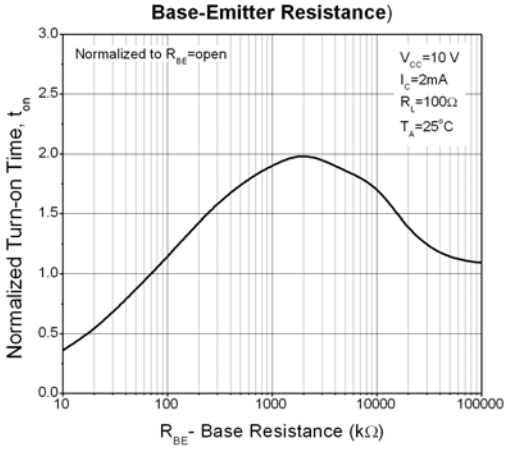
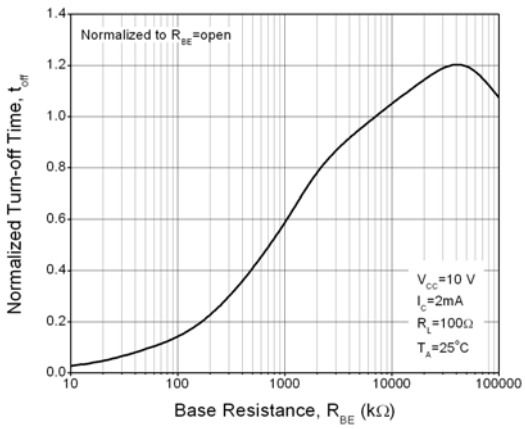


Figure 10. Turn-off Time vs Base-Emitter Resistance



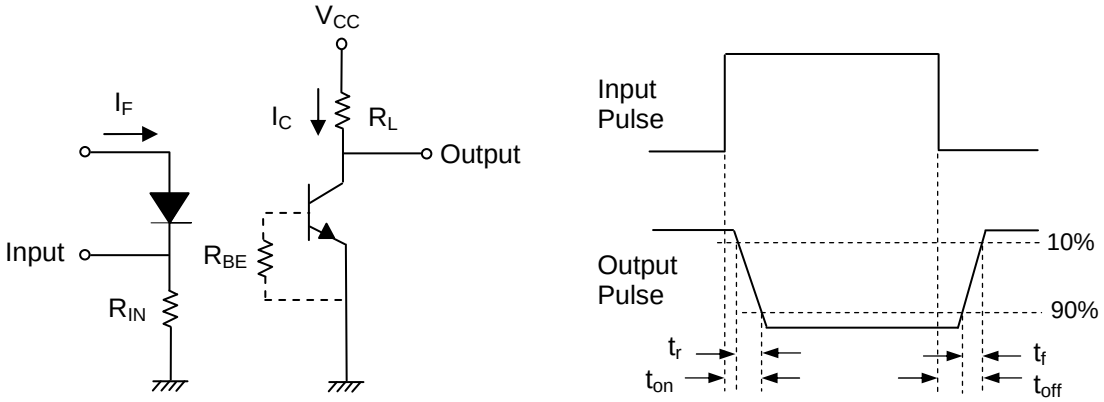


Figure 11. Switching Time Test Circuit & Waveforms

Order Information

Part Number

H11AAXY(Z)-V

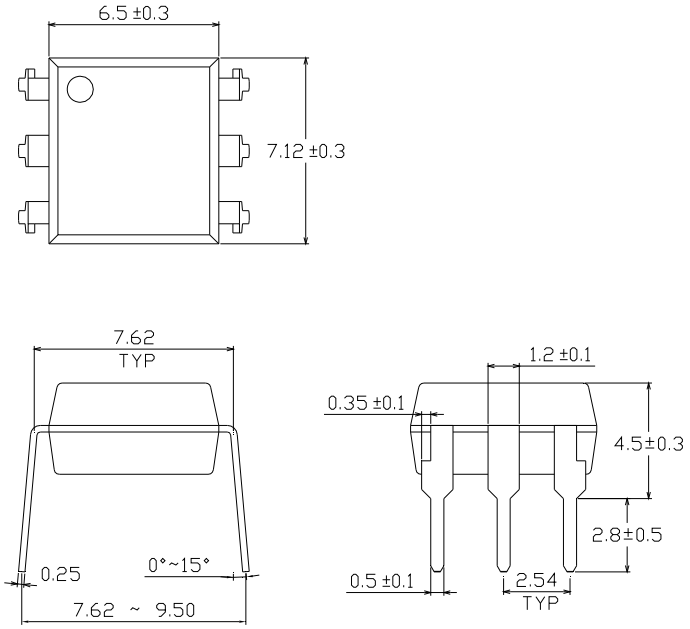
Note
X = Part no. (1, 2, 3 or 4)
Y = Lead form option (S, S1, M or none)
Z = Tape and reel option (TA, TB or none).
V= VDE safety (optional)

Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
M	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

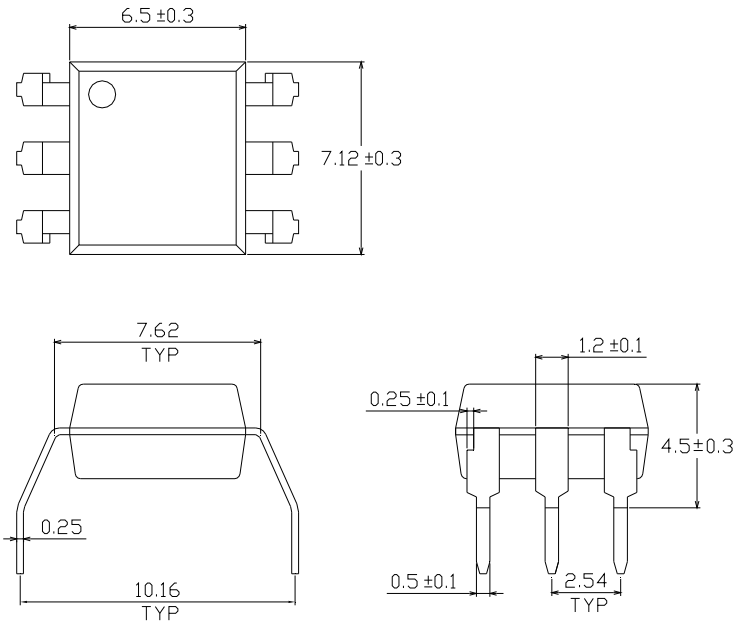
Package Drawings

(Dimensions in mm)

Standard DIP Type



Option M Type



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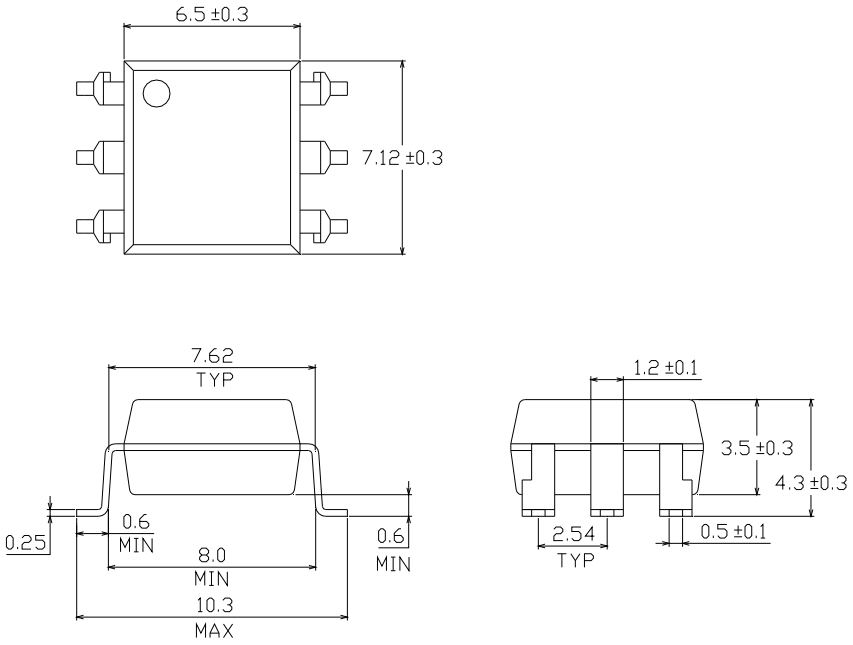
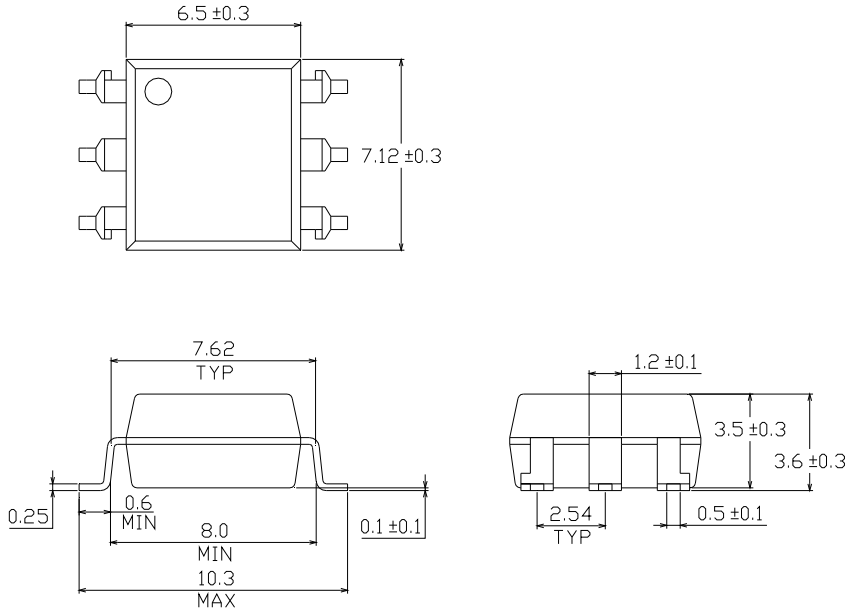
Option S Type



Option S1 Type



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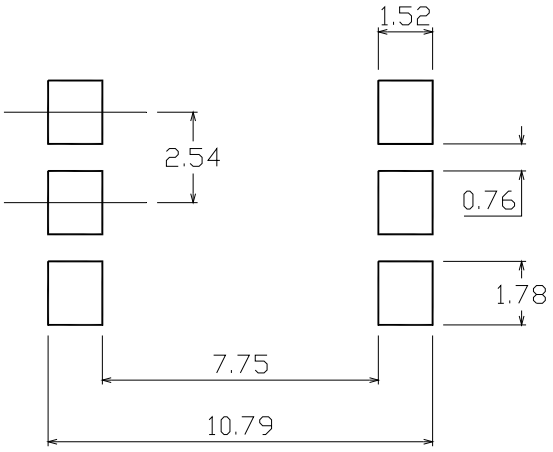
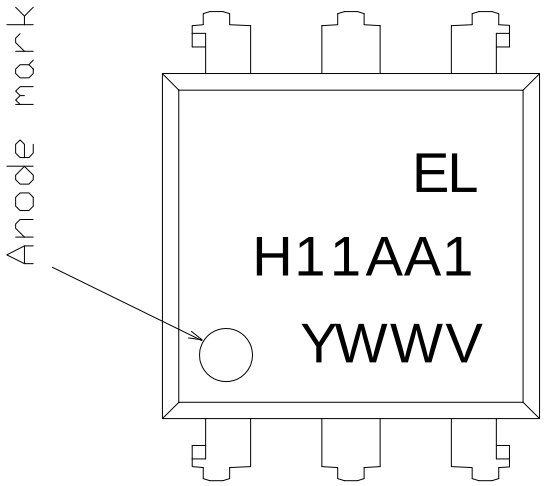
Recommended pad layout for surface mount leadform



Device Marking



Notes

EL	denotes Everlight
H11AA1	denotes Part Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE safety (optional)

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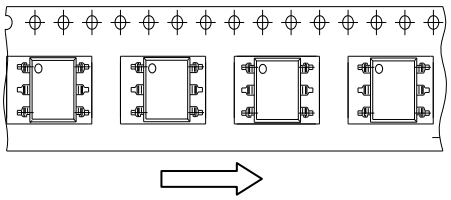
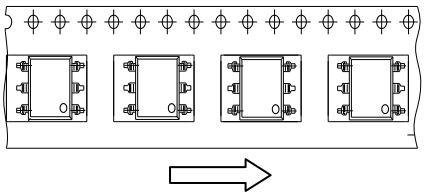
Tape & Reel Packing Specifications

Option TA



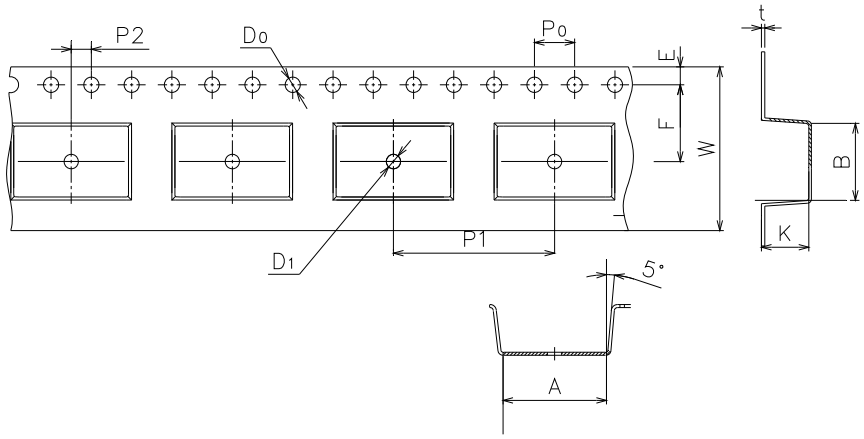
Direction of feed from reel

Option TB



Direction of feed from reel

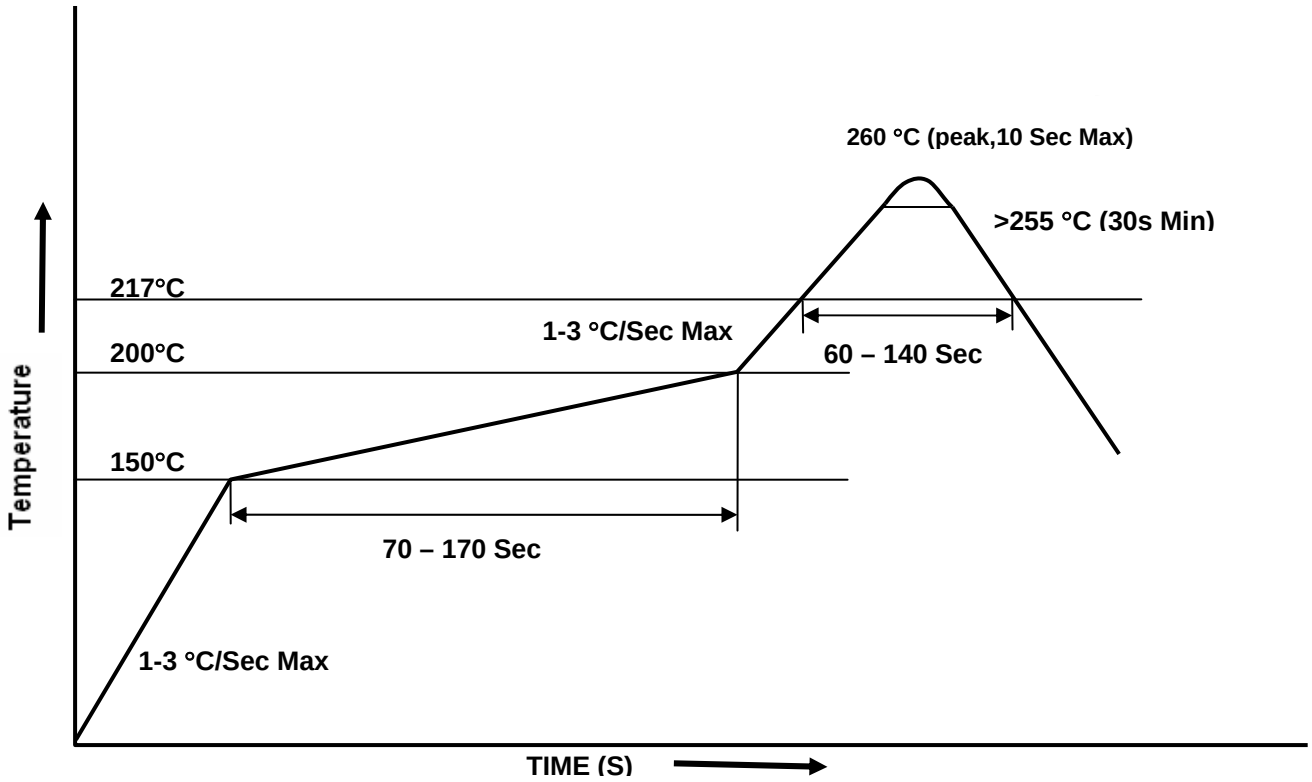
Tape dimensions



Dimension No.	A	B	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.52±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1

Dimension No.	Po	P1	P2	t	W	K
Dimension (mm)	4.0±0.15	16.0±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

Solder Reflow Temperature Profile



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1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.

2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.